Product data sheet

1. General description

AC Thyristor power switch in a SOT54 plastic package with self-protective capabilities against low and high energy transients

2. Features and benefits

- Exclusive negative gate triggering
- Full cycle AC conduction
- High noise immunity
- Remote gate separates the gate driver from the effects of the load current
- Very sensitive gate for lowest gate trigger current
- Safe clamping of low energy over-voltage transients
- Self-protective turn-on during high energy voltage transients

3. Applications

- Fan motor circuits
- Pump motor circuits
- Lower-power highly inductive, resistive and safety loads

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DRM}	repetitive peak off- state voltage		-	-	600	V
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)} = 25 ^{\circ}C$; $t_p = 20 \text{ms}$; Fig. 2; Fig. 3	-	-	8	А
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 71 °C; <u>Fig. 1</u>	-	-	0.8	Α
V _{PP}	peak pulse voltage	$T_j = 25$ °C; non-repetitive, off-state; Fig. 4	-	-	2	kV
Static characte	eristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V; } I_T = 100 \text{ mA; LD+ G-;}$ $T_j = 25 \text{ °C; } Fig. 6$	0.5	-	5	mA
		$V_D = 12 \text{ V; } I_T = 100 \text{ mA; LD- G-;}$ $T_j = 25 \text{ °C; } Fig. 6$	0.5	-	5	mA
V _{CL}	clamping voltage	I_{CL} = 0.1 mA; t_p = 1 ms; $T_j \le$ 125 °C	650	-	-	V





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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	СМ	common		LD I
2	G	gate		
3	LD	load	₩₩ ₩₩ 3 2 1 TO-92 (SOT54)	G →• ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
ACT108-600D	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54
ACT108-600D/DG	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54

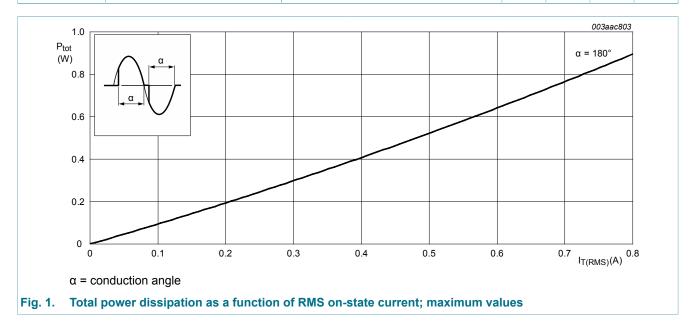
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7. Limiting values

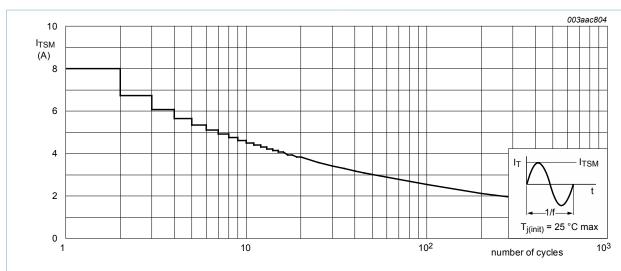
Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	M	lin	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-		600	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 71 °C; <u>Fig. 1</u>	-		0.8	Α
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_{j(init)} = 25 ^{\circ}C$; $t_p = 16.7 \text{ms}$	-		8.8	A
		full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 20 \text{ ms}$; Fig. 2; Fig. 3	-		8	A
I ² t	I2t for fusing	t _p = 10 ms; SIN	-		0.32	A ² s
dI _T /dt	rate of rise of on-state current	$I_T = 1 \text{ A}$; $I_G = 10 \text{ mA}$; $dI_G/dt = 0.2 \text{ A/}\mu\text{s}$	-		50	A/µs
I _{GM}	peak gate current	t = 20 μs	-		1	Α
V_{GM}	peak gate voltage		-		15	V
P _{G(AV)}	average gate power	over any 20 ms period	-		0.1	W
T _{stg}	storage temperature		-4	40	150	°C
T _j	junction temperature		-		125	°C
V _{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; Fig. 4	-		2	kV



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f = 50 Hz

Fig. 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

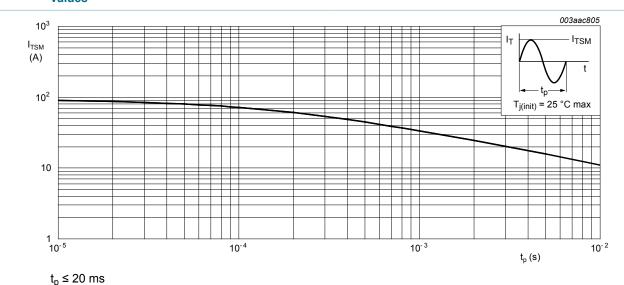


Fig. 3. Non-repetitive peak on-state current as a function of pulse width; maximum values

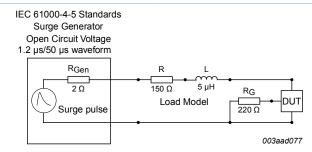


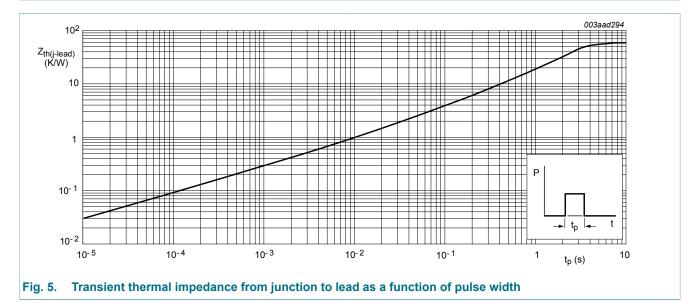
Fig. 4. Test circuit for inductive and resistive loads with conditions equivalent to IEC 61000-4-5

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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-lead)}	thermal resistance from junction to lead	full cycle with heatsink compound; Fig. 5	-	-	60	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	full cycle; printed-circuit board mounted; lead length 4 mm	-	150	-	K/W



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Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics		'			
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 100 \text{ mA}; LD+ G-;$ $T_j = 25 \text{ °C}; Fig. 6$	0.5	-	5	mA
		$V_D = 12 \text{ V}; I_T = 100 \text{ mA}; LD- G-;$ $T_j = 25 \text{ °C}; Fig. 6$	0.5	-	5	mA
IL	latching current	$V_D = 12 \text{ V}; I_G = 100 \text{ mA}; LD+ G-;$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	25	mA
		$V_D = 12 \text{ V}; I_G = 100 \text{ mA}; LD- G-;$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	25	mA
l _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 8</u>	-	-	20	mA
V _T	on-state voltage	I _T = 1.1 A; T _j = 25 °C; <u>Fig. 9</u>	-	-	1.3	V
V _{GT}	gate trigger voltage	V _D = 400 V; I _T = 100 mA; T _j = 125 °C	0.15	-	-	V
		V _D = 12 V; I _T = 100 mA; T _j = 25 °C	-	-	0.9	V
I _D	off-state current	V _D = 600 V; T _j = 25 °C	-	-	2	μA
		V _D = 600 V; T _j = 125 °C	-	-	0.2	mA
V _{CL}	clamping voltage	I _{CL} = 0.1 mA; t _p = 1 ms; T _j ≤ 125 °C	650	-	-	V
Dynamic cl	narateristics		l			
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T_j = 125 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 10	300	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	V_D = 400 V; T_j = 125 °C; $I_{T(RMS)}$ 1 A; dV_{com}/dt = 15 V/ μ s; gate open circuit; Fig. 11; Fig. 12	0.15	-	-	A/ms

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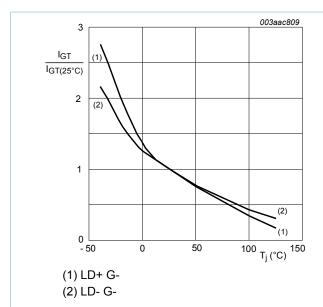


Fig. 6. Normalized gate trigger current as a function of junction temperature

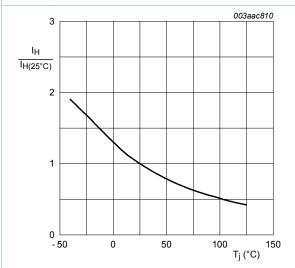


Fig. 8. Normalized holding current as a function of junction temperature

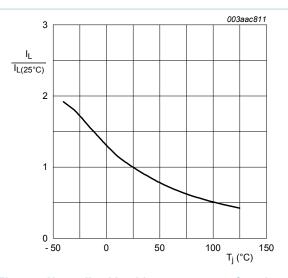
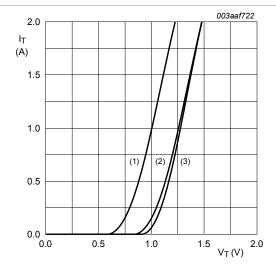


Fig. 7. Normalized latching current as a function of junction temperature



 $V_o = 0.758 \text{ V}; R_s = 0.263 \Omega$

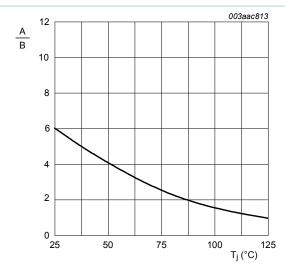
(1) T_j = 125 °C; typical values

(2) T_j = 125 °C; maximum values

(3) T_i = 25 °C; maximum values

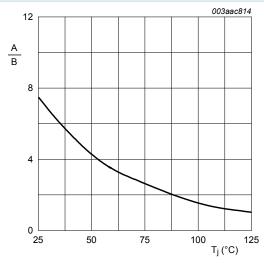
Fig. 9. On-state current as a function of on-state voltage

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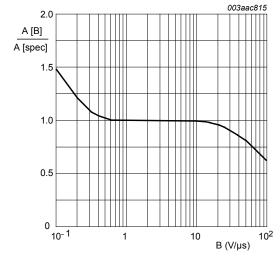
A = dV_D/dt at condition T_j °C B = dV_D/dt at condition T_i [125] °C

Fig. 10. Normalized rate of rise of off-state voltage as a function of junction temperature



A = dI_{com}/dt at condition T_j °C B = dI_{com}/dt at condition T_j [125] °C V_D = 400 V

Fig. 11. Normalized critical rate of rise of commutating current as a function of junction temperature



A [B] = dI_{com}/dt at condition B, dV_{com}/dt A [spec] is the data sheet value for dI_{com}/dt turn-off time is less than 20 ms

Fig. 12. Normalized critical rate of change of commutating current as a function of critical rate of change of commutating voltage; minimum values

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10. Package outline

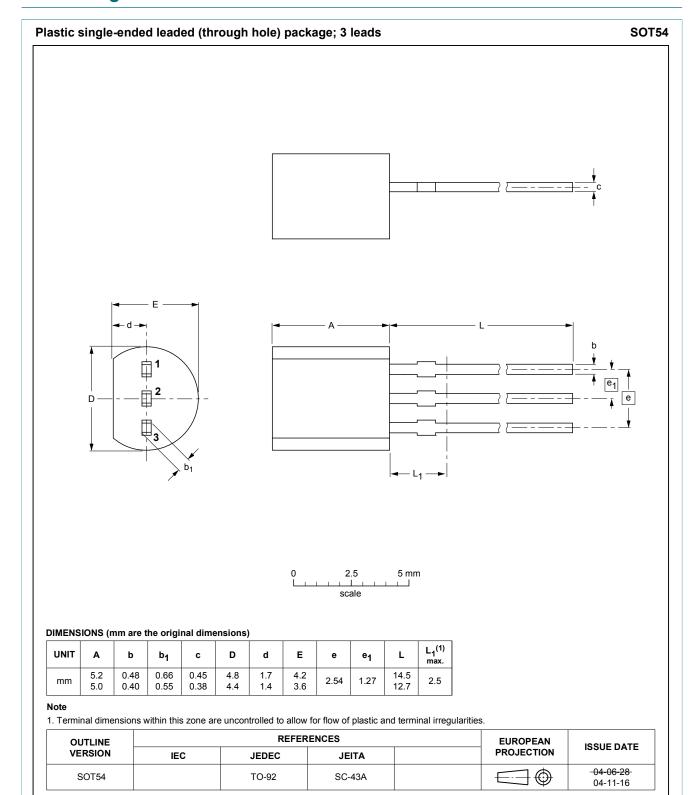


Fig. 13. Package outline TO-92 (SOT54)

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